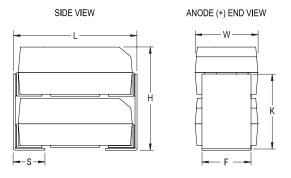
## KEMET Part Number: TSP2O307M025AHE045H543



## TSP, Tantalum, Polymer Tantalum, HRA, 300 uF, 20%, 25 VDC, 20



Dimensions		
Case Code	20	
L	7.9mm +/-0.38mm	
W	6.1mm +/-0.4mm	
Н	8.9mm +/-0.38mm	
S	1.4mm +/-0.38mm	
F	4.1mm +/-0.2mm	
К	6.6mm +/-0.38mm	

Packaging Specifications		
Packaging:	T&R, 178mm	

General Information		
Series:	TSP	
Dielectric:	Polymer Tantalum	
Style:	Stacked Chip	
Description:	SMD, Polymer, KO, Stacks, High Reliability	
Features:	High Reliability	
RoHS:	No	
Prop 65:	WARNING: Cancer and reproductive harm - www.p65warnings.ca.gov.	
SCIP Number:	30e82d35- b509-48ec-8c77-2d5ec01b3abc	
Termination:	Solder Coated	
Termination (Stack):	Solder Coated	
AEC-Q200:	No	

Specifications		
Capacitance:	300 uF	
Capacitance Tolerance:	20%	
Voltage DC:	25 VDC (105C), 16.75 VDC (125C)	
Temperature Range:	-55/+125°C	
Rated Temperature:	105°C	
Dissipation Factor:	10% 120Hz 25C	
Failure Rate:	N/A	
Resistance:	25 mOhms (100kHz 25C)	
Leakage Current:	750 uA (5min 25°C)	

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.



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